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COUNT	DESCRIPTION	OF REVI	SIONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF	REVISIONS	BY	CHKD	DAT	Œ	
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APPLICA	BLE STAN	DARD				·									
	OPERATING TEMPERATUR	ERATING MPERATURE RANGE		-55 °C TO 85 °C _{TEI}					RAGE IPERATURE RANGE °C TO °C				;		
RATING VOLTA		AGE		250 V AC									•		
		ENT		0.5 A A			APF	PLICABLE CABLE							
SPECIFICATIONS															
17	EM	TEST METHOD						REQUIREMENTS				QT	ΑT		
	RUCTION	1 1201 111200													
	VISUALLY AND BY MEASURING INSTRUMENT.						ACCORDING TO I	DRAWING.			ТО	0			
MARKING	CONFIRMED VISUALLY.										0	Ō			
FLECTE	IC CHARA	L CTERISTICS							L				10		
	100 mA (DC OR 1000 Hz). 1							35 mΩ MAX.				ТО	О		
INSULATIO	500 V DC.							500 MΩ MIN.				+ -			
RESISTAN												0	0		
VOLTAGE PROOF									NO FLASHÖVER OR BREAKDOWN.				0	0	
_	VICAL CHA														
INSERTION WITHDRAW	MEASURED BY APPLICABLE CONNECTOR.							19.7 N MIN.				0			
MECHANIC	1000 TIMES INSERTIONS AND EXTRACTIONS.							73.5 N MAX. (1) CONTACT RESISTANCE: 35 mΩ MAX.				0	 _ 		
OPERATIO							② NO DAMAGE, OF PARTS.				,				
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, m/s² AT 2 h,						NO DAMAGE, CR. OF PARTS.	ACK AND LC	OSEN	IESS,	0	_			
SHOCK		FOR 3 DIRECTIONS. 490 m/s² DURATION OF PULSE 11 ms										0			
	AT 3 TIMES FOR 6 DIRECTIONS.											\perp			
	NMENTAL														
RAPID CHANGE OF TEMPERATURE		TEMPERATURE _55 → 5~35 → 85 → 5~35 ℃ TIME 30 → 2~3 → 30 → 2~3 min UNDER 5 CYCLES.											0	-	
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ℃, 90~95 %, 96 h.							INSULATION RESISTANCE: 1 MΩ MIN. (AT HIGH HUMIDITY.)				0	-	
CORROSION SALT MIST		EXPOSED IN 5 % SALT WATER SPRAY FOR							100 MΩ MIN. (AT DRY.) NO HEAVY CORROSION.				6		
RESISTANCE TO		48 h.							INO DEFORMATION OF CASE AND						
SOLDERING HEAT		SOLDER TEMPERATURE, 260 ± 5 °C FOR IMMERSION, DURATION 10 ± 1 S.							EXCESSIVE LOOSENESS OF THE TERMINALS.				0	_	
SOLDERABILITY		SÖLDERED AT SOLDER TEMPERATURE, 245 ± 2 ℃ FOR IMMERSION, DURATION 3 ± 1 S.							MIN. 95 % OF SOLDER IMMERSED AREA SHALL BE COVERED NEW SOLDER COATING.				0	_	
NOTE.	NOTE: 1 MEASUREMENT POINT OF CONTACT RESISTANCE														
								(10)							
					E	 		\coprod							
					<u>.</u>		<u> </u>								
REMARKS	<u> </u>					14	· · · · · · · · · · · · · · · · · · ·	RAWN	DESIGNED	CHECKED	APPRO	OVED I	RELEA	SED	
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	Unless otherwise specified, refer to JIS C 5402.														
Unless otherwise specified, refer to JIS C 5402. O3 /o. /o O3 (O IS O3 (IO IS O3 (IO															
Note QT:0	aualification Tes	st AT:A	ssuranc	e Test	: O:A	pplicable Te	est		IDADT N	<u> </u>					
HS HIROSE ELECTRIC CO., LTD. SPECIFICATION SHEET DX10G1M-50S(50)															
CODE NO.(O		DRAWING NO. ELC4-120447-02					CL230-5227-1-50					1/			
CL		j	į t	LLU	4-17	∠U44/-	ひと		GL23	U-522/-	1-5	U	- 1	/1	